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### 30V N-Channel PowerTrench<sup>o</sup> MOSFET

### **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

### Applications

- DC/DC converter
- Motor Drives

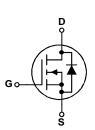
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## D-PAK (TO-252) G D S

### Features

- 75 A, 30 V  $R_{DS(ON)} = 6.2 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 8.0 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge
- Fast switching
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$



### Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	
ID	Drain Current – Continuous	(Note 3)	75	A
	– Pulsed	(Note 1a)	100	
PD	Power Dissipation for Single Operation	(Note 1)	71	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperat	ture Range	-55 to +175	°C

### **Thermal Characteristics**

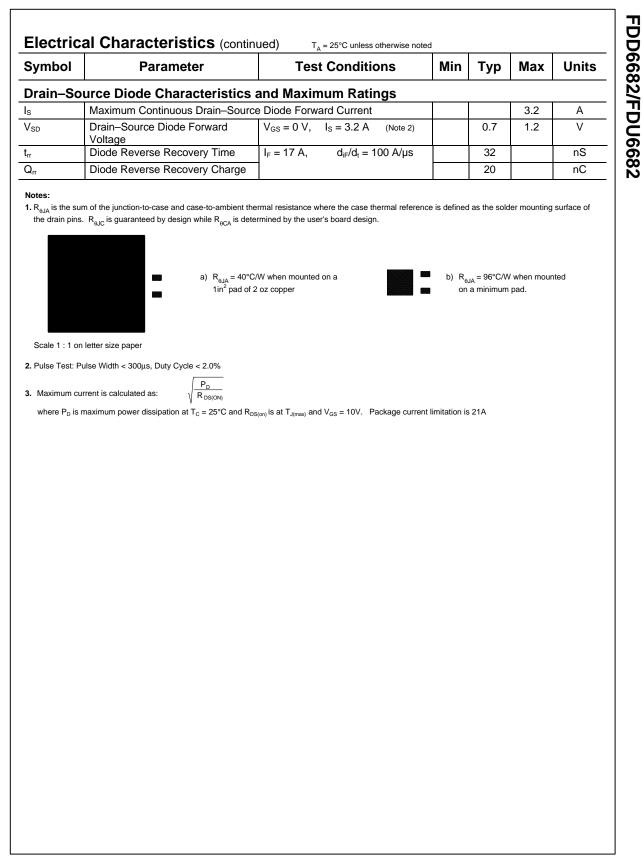
$R_{ ext{ ext{ ext{ ext{ ext{ ext{ ext{ ext$	Thermal Resistance, Junction-to-Case	(Note 1)	2.1	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	

### Package Marking and Ordering Information

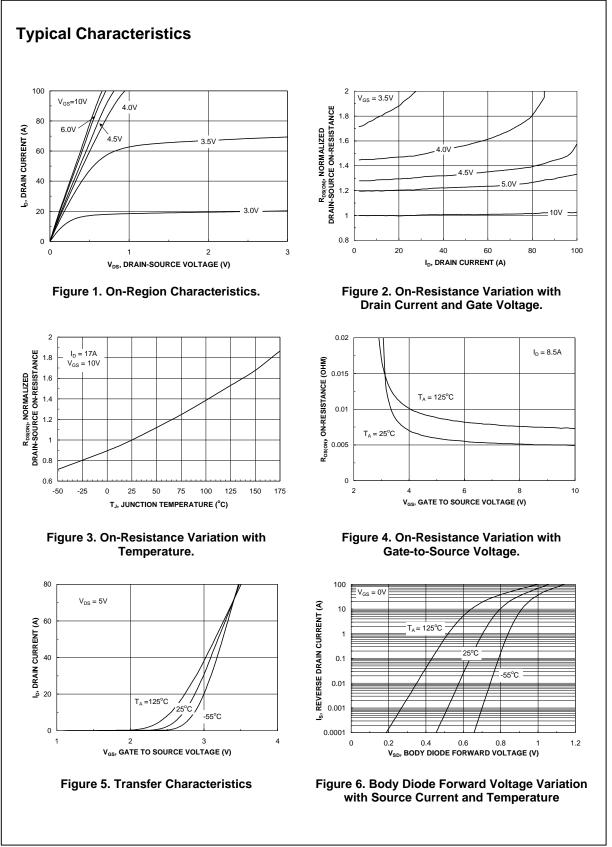
Device Marking	Device	Package	Reel Size	Tape width	Quantity
FDD6682	FDD6682	D-PAK (TO-252)	13"	12mm	2500 units
FDU6682	FDU6682	I-PAK (TO-251)	Tube	N/A	75

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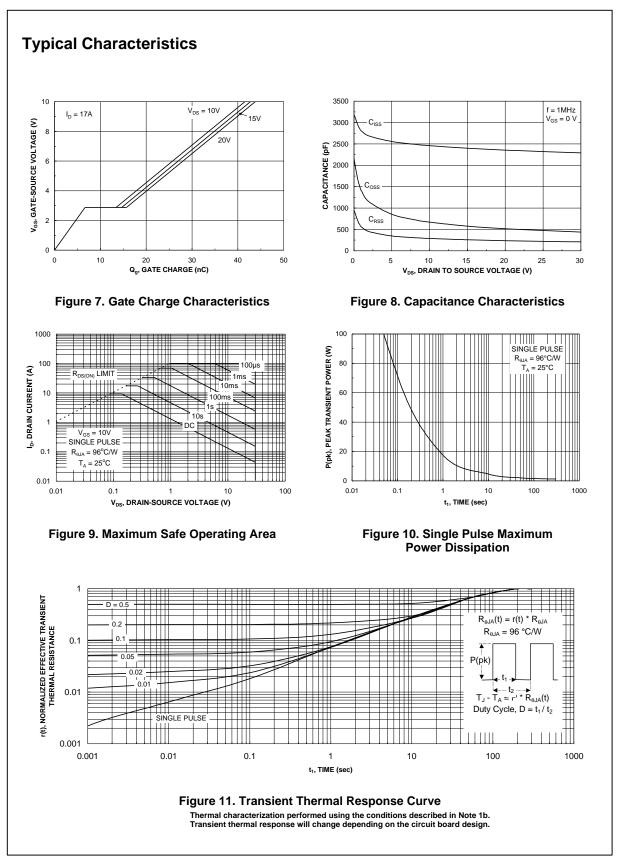
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings (Note	2)				
W <sub>DSS</sub>	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$ , $I_D = 17 \text{ A}$			240	mJ
I <sub>AR</sub>	Drain-Source Avalanche Current				17	А
Off Chara	acteristics	1				
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	30			V
$\Delta BV_{DSS}$ $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		20		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	1.9	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-7		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = 10 \ V, & I_D = 17 \ A \\ V_{GS} = 4.5 \ V, & I_D = 15 \ A \\ V_{GS} = 10 \ V, & I_D = 17 \ A, \ T_J \! = \! 125^\circ \! C \end{array} $		5.2 6.4 8.0	6.2 8 11.9	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50			А
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ , $I_{D} = 17 A$		65		S
	Characteristics	•				
C <sub>iss</sub>	Input Capacitance			2400		pF
Coss	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		577		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0 MHz		258		pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV, f = 1.0 MHz		1.4		Ω
Switchin	g Characteristics (Note 2)	•				
t <sub>d(on)</sub>	Turn–On Delay Time			14	20	ns
tr	Turn–On Rise Time	$V_{DD} = 15 V$ , $I_D = 1 A$ ,		12	37	ns
t <sub>d(off)</sub>	Turn–Off Delay Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		38	64	ns
t <sub>f</sub>	Turn–Off Fall Time			18	32	ns
Qg	Total Gate Charge			24	31	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS} = 15V,$ $I_{D} = 17 A,$ $V_{GS} = 5 V$		6.5		nC
Q <sub>qd</sub>	Gate-Drain Charge	$V_{GS} = 5$ V		8.1		nC



FDD6682/FDU6682 Rev H(W)



FDD6682/FDU6682 Rev H(W)



FDD6682/FDU6682 Rev H(W)

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